

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3560343

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	KENICHIRO SATO	09/29/2015
RECEIVING PARTY DATA		
Name:	FUJI ELECTRIC CO., LTD.	
Street Address:	1-1 TANABESHINDEN, KAWASAKI-KU,	
City:	KAWASAKI-SHI,	
State/Country:	JAPAN	
Postal Code:	210-9530	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14877334	
CORRESPONDENCE DATA		
Fax Number:	(703)518-5499	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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Correspondent Name:	KANESAKA BERNER AND PARTNERS LLP	
Address Line 1:	2318 MILL ROAD	
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Address Line 4:	ALEXANDRIA, VIRGINIA 22314-2848	
ATTORNEY DOCKET NUMBER:	FUJ-276	
NAME OF SUBMITTER:	MANABU KANESAKA	
SIGNATURE:	/Manabu KANESAKA/	
DATE SIGNED:	10/07/2015	
Total Attachments: 1		
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ASSIGNMENT

For value received, I, Kenichiro SATO having post office address at c/o FUJI ELECTRIC CO., LTD., 1-1 Tanabeshinden, Kawasaki-ku, Kawasaki-shi 210-9530, Japan hereby sell, assign and transfer to FUJI ELECTRIC CO., LTD. corporation existing under the laws of Japan located at 1-1 Tanabeshinden, Kawasaki-ku, Kawasaki-shi 210-9530, Japan and its successors, assigns, and legal representatives the entire right, title, and interest for all countries including the United States of America, in' and to certain inventions relating to METHOD FOR MANUFACTURING SEMICONDUCTOR MODULE AND INTERMEDIATE ASSEMBLY UNIT OF THE SAME described in application for Letters Patent of the United States, executed by me on this date, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I have full right so to do, and agree that I will communicate to said Company or its representatives any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature Kenichiro SATO Date September 29, 2015
Kenichiro SATO